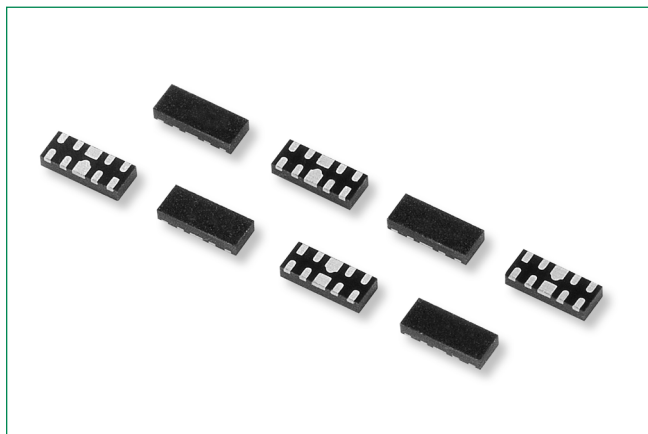


SP1064 Series

General Purpose ESD Protection, 8.5pF, 15 kV Diode Array



Description

The SP1064 is an avalanche breakdown diode fabricated in a proprietary silicon avalanche technology protect each I/O pin to provide a high level of protection for electronic equipment that may experience destructive electrostatic discharges (ESD). These robust diodes can safely absorb repetitive ESD strikes above the maximum level specified in IEC 61000-4-2 international standard (Level 4, $\pm 8\text{kV}$ contact discharge) without performance degradation. Their very low loading capacitance also makes them ideal for protecting high speed signal pins.

Features & Benefits

- ESD, IEC 61000-4-2, $\pm 15\text{kV}$ contact, $\pm 20\text{kV}$ air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Lightning, 2A (8/20 μs as defined in IEC 61000-4-5, 2nd Edition)
- Low capacitance of 8.5pF (TYP) per I/O
- Low leakage current of 0.05 μA (TYP) at 60V
- Small form factor μDFN (JEDEC MO-229) package saves board space
- Lead free and RoHS compliant
- AEC-Q101 qualified

Additional Information



Resources

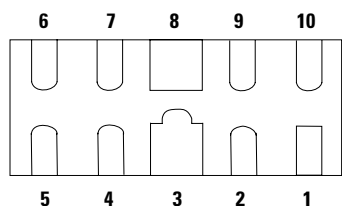


Accessories

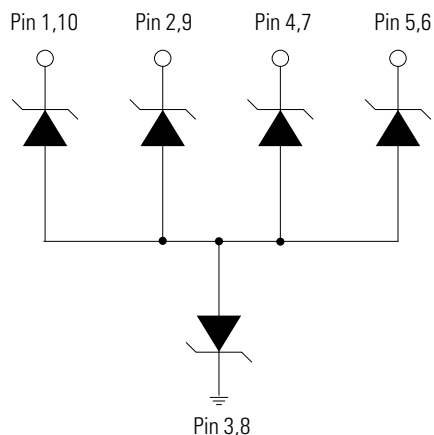


Samples

Pinout



Functional Block Diagram



Life Support Note:

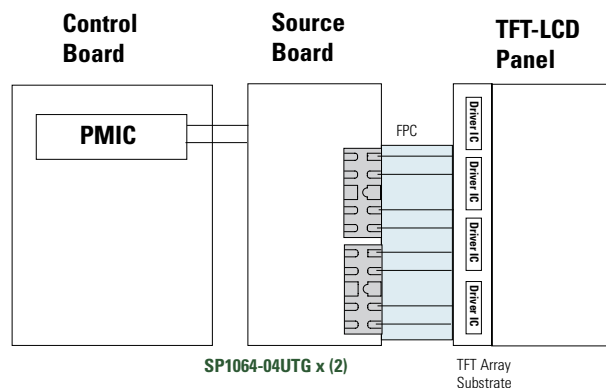
Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

Applications

- LCD/PDP TVs
- DVD Players
- Desktops
- MP3/PMP
- Set Top Boxes
- Mobile Phones
- Notebooks
- Digital Cameras

Application Example



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Absolute Maximum Ratings

Symbol	Parameter	Value	Units
I_{PP}	Peak Current ($t_p=8/20\mu s$)	2.0	A
T_{OP}	Operating Temperature	-40 to 125	°C
T_{STOR}	Storage Temperature	-55 to 150	°C

Caution: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Characteristics ($T_{OP}=25^\circ C$)

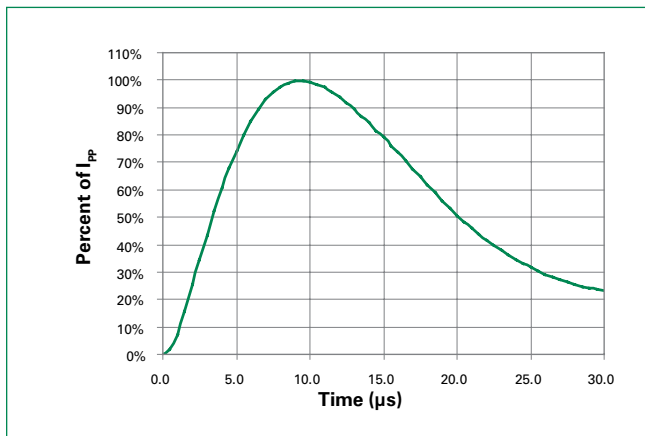
Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Reverse Standoff Voltage	V_{RWM}	$I_R \leq 1\mu A$			60	V
Reverse Leakage Current	I_{LEAK}	$V_R=60V$, Any I/O to GND		0.05		μA
Clamp Voltage ¹	V_C	$I_{PP}=1A$, $t_p=8/20\mu s$, Fwd		81		V
		$I_{PP}=2A$, $t_p=8/20\mu s$, Fwd		95		V
Dynamic Resistance ³	R_{DYN}	TLP, $t_p=100ns$, I/O to GND		4		Ω
ESD Withstand Voltage ¹	V_{ESD}	IEC 61000-4-2 (Contact)	± 15			kV
		IEC 61000-4-2 (Air)	± 20			kV
Line Capacitance ^{1,2}	C_L	Reverse Bias=0V; $f=1MHz$		8.5		pF

Note 1: Parameter is guaranteed by design and/or component characterization.

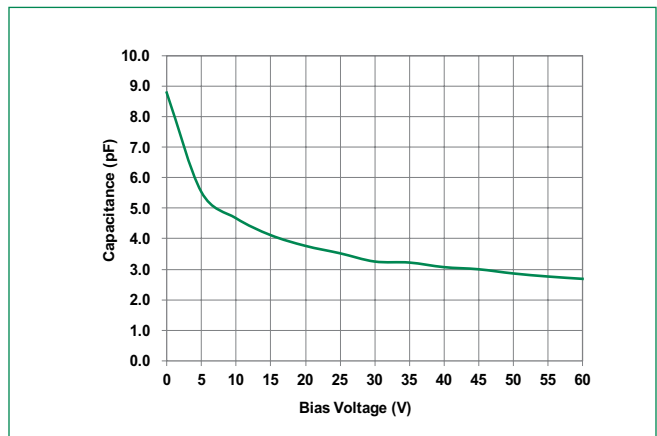
Note 2: Test equipment accuracy $\pm 50F$.

Note 3: Transmission Line Pulse (TLP) with 100ns width, 2ns rise time, and average window $t1=70ns$ to $t2=90ns$

8/20 μs Pulse Waveform



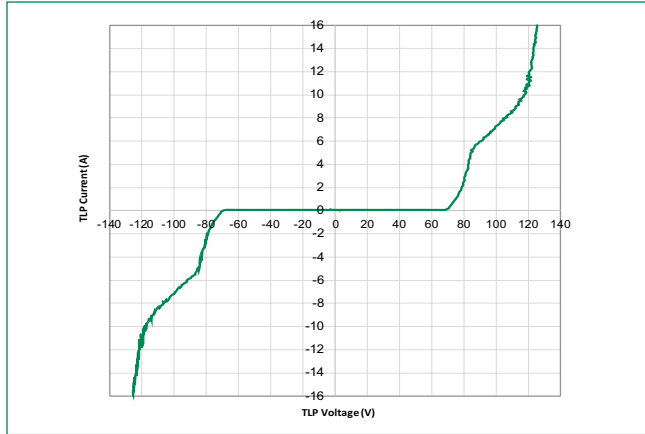
Capacitance vs. Reverse Bias



SP1064 Series

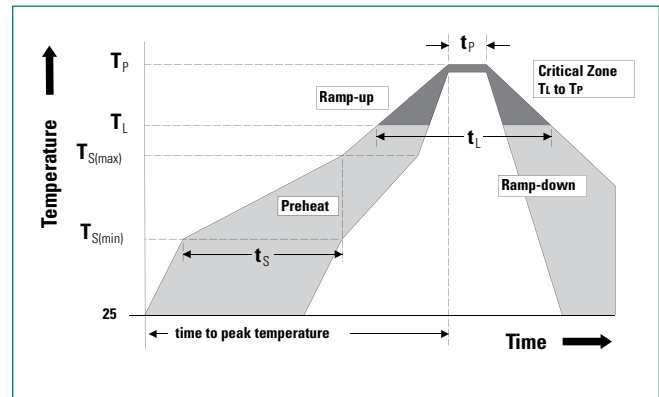
General Purpose ESD Protection, 8.5pF, 15 kV Diode Array

Transmission Line Pulsing (TLP) Plot



Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 120 secs
Average ramp up rate (Liquidus) Temp (T_L) to peak		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		30 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		260°C



Product Characteristics

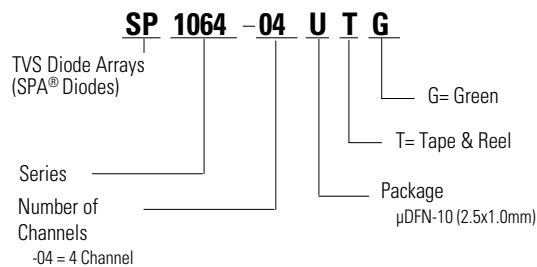
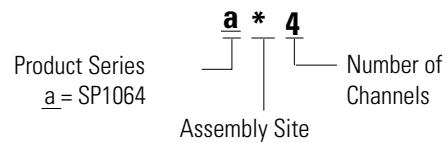
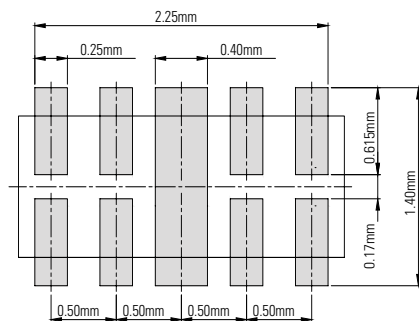
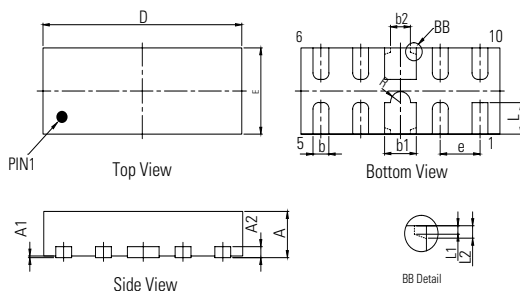
Lead Plating	Tin
Lead Material	Copper Alloy
Lead Coplanarity	0.0004 inches (0.102mm)
Substitute Material	Silicon
Body Material	Molded Compound
Flammability	UL Recognized compound meeting flammability rating V-0

SP1064 Series

General Purpose ESD Protection, 8.5pF, 15 kV Diode Array

Ordering Information

Part Number	Package	Min. Order Qty.
SP1064-04UTG	μDFN-10	3000

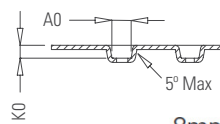
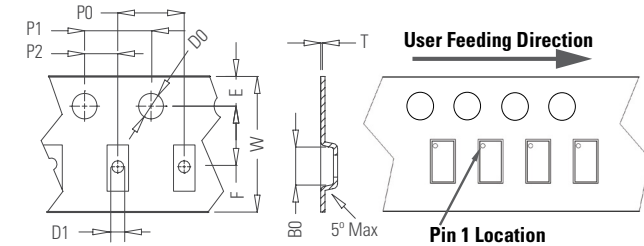
Part Numbering System**Part Marking System****Package Dimensions — μDFN-10 (2.5x1.0x0.5mm)**

Recommended Soldering Layout

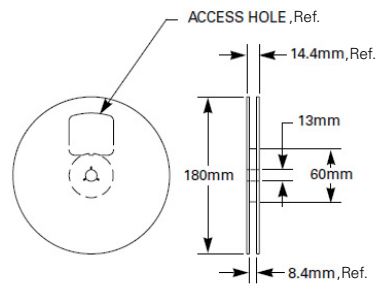
Package	μDFN-10 (2.5x1.0x0.5mm)			
JEDEC	MO-229			
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	0.45	0.60	0.018	0.024
A1	0.00	0.05	0.000	0.002
A2	0.10	0.20	0.004	0.008
b	0.15	0.25	0.006	0.010
b1	0.35	0.45	0.014	0.018
b2	0.25 REF (Optional)		0.010 REF (Optional)	
D	2.40	2.60	0.098	0.106
E	0.90	1.10	0.037	0.045
L	0.28	0.48	0.011	0.019
e	0.50 BSC		0.020 BSC	
R	0.05	0.15	0.002	0.006

SP1064 Series

General Purpose ESD Protection, 8.5pF, 15 kV Diode Array

Embossed Carrier Tape & Reel Specification — μ DFN-10

8mm TAPE AND REEL



Package	μ DFN-10 (2.5x1.0x0.5mm)
Symbol	Millimeters
A0	1.30 +/- 0.10
B0	2.83 +/- 0.10
D0	\varnothing 1.50 + 0.10
D1	\varnothing 1.00 + 0.25
E	1.75 +/- 0.10
F	3.50 +/- 0.05
K0	0.65 +/- 0.10
P0	4.00 +/- 0.10
P1	4.00 +/- 0.10
P2	2.00 +/- 0.05
T	0.254 +/- 0.02
W	8.00 + 0.30 /- 0.10

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